



# **TO-2013BC-MRE**

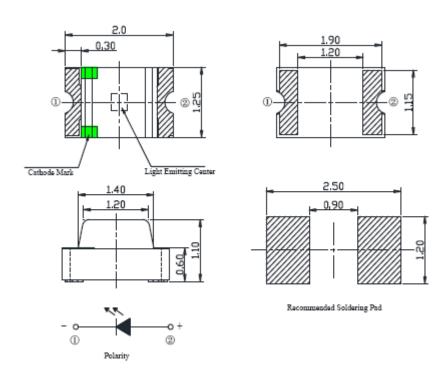
## **Surface Mount Device LED**

Part Number	Chip		Lens Color	
rait Number	Material	Source Color	Lens Color	
TO-2013BC-MRE	AlGaInP	Ultra Bright Red	Water clear	

## **Features**

- IC compatible. Top view type.
- · Compatible with automatic placement equipment
- Compatible with infrared and vapor phase reflow soldering process
- Pack in 8 mm tape on 7" diameter reel
- · RoHS compliant.
- Moisture sensitivity Level: level 3

## **Dimensions**



#### Notes:

- 1. All dimensions are in millimeter.
- 2. Tolerance is ±0.1mm unless individual mark noted.

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Doc No: GS1705011





## Absolute Maximum Rating @ Ta=25°C

Parameter	Maximum Rating	Unit
Peak Forward Current (1/10 Duty Cycle, 0.1ms Pulse Width)	80	mA
Power Dissipation	75	mW
Continuous Forward Current	25	mA
Reverse Voltage	5	V
Operating Temperature Range	-40°C to +80°C	
Storage Temperature Range	-40°C to +100°C	
IR Reflow Soldering Profile For Lead Free Soldering	260°C / 10sec	

# Electrical / Optical Characteristic @ Ta=25°C

Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	lv	51		146	mcd	I <sub>F</sub> =20mA
Viewing Angle	2θ <sub>1/2</sub>		120		deg	I <sub>F</sub> =20mA
Forward Voltage	VF		1.9		V	I <sub>F</sub> =20mA
Dominant Wavelength	λd		630		nm	I <sub>F</sub> =20mA
Spectral Line Half-Width	Δλ		15		nm	I <sub>F</sub> =20mA
Reverse Current	I <sub>R</sub>			10	μΑ	V <sub>R</sub> =5V

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## **Bin Code List for Reference**

Luminous Intensity	Unit: mcd@20mA		
Bin Code	Min	Max	
E1	51	66	
E2	66	86	
E3	86	112	
E4	112	146	

Tolerance of Luminous Intensity on each bin is ±15%

Dominant Wavelength	Unit: nm@20mA	
Bin Code	Min	Max
618621	618	621
621624	621	624
624627	624	627
627630	627	630

Tolerance of Dominant Wavelength on each bin is ±1nm